

11-14-2000



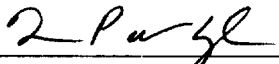
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OCT 13 2000

10-13-00

To the Honorable Commissioner of Patents & Trademarks: Please record the attached original document(s) or copy thereof.

<p>1. Name of conveying parties:</p> <p>Bok-Nam Jang, Se-Jong Kim, Young-Kil Chang, Gyu-Cheol Lee</p>	<p>2. Name and address of receiving party(ies):</p> <p>CHEIL INDUSTRIES INC.L 290 Gongdan-dong, Kumi-shi, Kyungbuk Republic of Korea</p> <p>There are no additional names or addresses attached.</p>
<p>3. Nature of conveyance: Assignment</p> <p>Execution date: September 26, 2000</p>	
<p>4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is:</p> <p>A. Application Serial No. 09 580 907</p> <p>There are no additional numbers attached.</p>	
<p>5. Send correspondence to:</p> <p>Maria Parrish Tungol 2231 Crystal Drive Suite 500 Arlington, VA 22202</p>	<p>6. Total no. of applications involved: <input type="text" value="1"/></p> <p>7. Total fee (37 CFR 3.41) = \$40</p> <p>A Credit Card Payment Form is enclosed.</p>
<p>9. Statement and signature</p> <p>To the best of the knowledge and belief of the undersigned, the foregoing information is true and correct and any attached copy is a true copy of the original document.</p> <p>Maria Parrish Tungol Attorney for Applicants Reg. No. 31,720</p> <p> Signature</p> <p>October 6, 2000 Date</p>	
<p>Total Number of pages, including cover sheet, attachments, and documents: <input type="text" value="4"/></p>	

ASSIGNMENT

WHEREAS, WE, Bok-Nam Jang, Se-Jong Kim, Young-Kil Chang, Gyu-Cheol Lee, and (hereafter, ASSIGNORS), all citizens of the Republic of Korea, and respectively residing at:

6-1101, Sangah Apt., 165 Okum-dong, Songpa-gu, Seoul. 138-13, Republic of Korea

20, 853-22, Ohjeon-dong, Uiwang-shi, Kyungki-do, 437-070, Republic of Korea,

160-3, Sadang-3dong, Tongjak-gu, Seoul, 156-093, Republic of Korea,

Jukong Apt. 150- 106, Cheoncheon-dong Changan-gu, Suwon-shi, Kyungki-do, 440-330, Republic of Korea,

are the inventors of the invention in **METHOD OF PREPARING FLAMEPROOF THERMOPLASTIC RESIN COMPOSITION** for which we have executed an application for Letters Patent of the United States on May 31 2000 as 09 580 907

and WHEREAS, CHEIL INDUSTRIES INC. (hereafter, ASSIGNEE), a corporation under the laws of Republic of Korea having a place of business at 290 Gongdan-dong, Kumi-shi, Kyungbuk Republic of Korea is desirous of obtaining the entire right, title and interest in, to and under the said invention and the said application;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, we, the said ASSIGNORS, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE the entire right, title and interest in, to and under all our inventions, whether joint or sole, disclosed in the said application and in, to and under all applications filed for Letters Patent of the United States for any of said inventions and in, to and under all patents granted on the said applications;

AND WE HEREBY further covenant and agree that we will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceeding, sign all lawful papers, and to execute all applications and papers necessary to obtain and maintain proper patent protection on said inventions;

AND WE HEREBY authorize and request the Commissioner of Patents and Trademarks of the United States to issue all patents on the said application to the said ASSIGNEE in accordance with the terms of this instrument;

ASSIGNMENT

IN TESTIMONY WHEREOF, we have each hereunto set our hand and seal on the date set opposite our signature.

Date: 9/26, 2000

Bok Nam Jang
Bok-Nam Jang

Date: 9/26, 2000

김성종
Se-Jong Kim

Date: 9/26, 2000

Young-Kil Chang
Young-Kil Chang

Date: 9/26, 2000

Gyu-Cheol Lee
Gyu-Cheol Lee

WITNESSES:

Date: September 26, 2000

Dukkyu Choi
Dukkyu Choi

Date: _____
